

# Product Change Notification - LIAL-19IVLH492

## Date:

30 Sep 2019 Product Category: 32-bit Microcontrollers Affected CPNs: 1

## Notification subject:

CCB 3655 Final Notice: Qualification of MMT as an additional assembly site for selected Atmel products of 58.85K and 58.8K wafer technologies available in 48L VQFN (7x7x0.9mm) package. **Notification text:** 

PCN Status: Final notification

PCN Type: Manufacturing Change

# **Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

# **Description of Change:**

Qualification of MMT as an additional assembly site for selected Atmel products of 58.85K and 58.8K wafer technologies available in 48L VQFN (7x7x0.9mm) package.

# Pre Change:

Assembled at ASE using EN-4900F die attach material.

# Post Change:

Assembled at ASE using EN-4900F die attach material or assembled at MMT using 3280 die attach material

# Pre and Post Change Summary:

	Pre Change	Post C	hange		
Assembly Site	ASE Inc. (ASE)	ASE Inc. (ASE)	Microchip Technology Thailand		
			(Branch) (MMT)		
Wire material	Au	Au	Au		
Die attach material	EN-4900F	EN-4900F	3280		
Molding compound material	G700	G700	G700		
Lead frame material	C194	C194	C194		



	MSL level	MSL 3	MSL 3	MSL 1
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# Impacts to Data Sheet:

Yes. POD (package outline drawing) change. See the changes below:

		Pre Change	e energee	Post Change					
Dimension Limit (in mm)	Min	Nor	Max	Min	Nor	Max			
Number of terminals		48		48					
Overall Height	0.8	0.85	0.9	0.8	0.9	1			
Standoff	0	0.02	0.05	0	-	0.05			
Terminal Thickness		0.20 REF		0.20 REF					
Overall Length		7.00 BSC		7.00 BSC					
Exposed Pad Length	5.5	5.6	5.7	5.5	5.6	5.7			
Overall Width		7.00 BSC		7.00 BSC					
Exposed Pad Width	5.5	5.6	5.7	5.5	5.6	5.7			
Terminal Width	0.17	0.25	0.3	0.2	0.25	0.3			
Terminal Length	0.3	0.4	0.5	0.3	0.4	0.5			
Pitch		0.50 BCS		0.50 BCS					

Note: These POD changes are within JEDEC limit so no significant impact other than a documentation change in the spec and/or datasheet.

#### **Change Impact**

None

### **Reason for Change:**

To improve productivity and on-time delivery performance by qualifying ASE as an additional assembly site.

### **Change Implementation Status:**

In Progress

### **Estimated First Ship Date:**

October 30, 2019 (date code: 1944)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts

### Time Table Summary:

	December 2018			September 2019				October 2019						
Workweek	49	50	51	52	>	36	37	38	39	40	41	42	43	44
Initial PCN Issue Date				Х										
Qual Report										V				
Availability										^				
Final PCN Issue Date										Х				
Estimated														V
Implementation Date														^

# Method to Identify Change:

Traceability code



### **Qualification Report:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

## **Revision History:**

December 27, 2018: Issued initial notification.

**September 30, 2019:** Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on October 30, 2019.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products. **Attachment(s):** PCN\_LIAL-<u>19IVLH492\_QUAL REPORT.pdf</u>

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. LIAL-19IVLH492 - CCB 3655 Final Notice: Qualification of MMT as an additional assembly site for selected Atmel products of 58.85K and 58.8K wafer technologies available in 48L VQFN (7x7x0.9mm) package.

Affected Catalog Part Numbers (CPN)

AT91SAM7S32B-MU AT91SAM7S32B-MU-999 ATSAM3N00AA-MU ATSAM3N00AA-MUR ATSAM3N0AA-MUR ATSAM3N0AA-MUR ATSAM3N1AB-MUR ATSAM3S1AB-MUR ATSAM3S1AB-MUR ATSAM3S2AA-MU ATSAM3S2AA-MUR ATSAM3S4AA-MUR